

FDP12N60NZ / FDPF12N60NZ N-Channel UniFETTM II MOSFET 600 V, 12 A, 650 m Ω

Features

- $R_{DS(on)}$ = 530 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 6 A
- Low Gate Charge (Typ. 26 nC)
- Low C_{rss} (Typ. 12 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

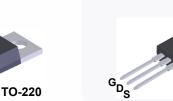
Applications

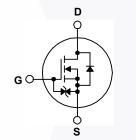
- LCD/ LED/ PDP TV
- Lighting
- Uninterruptible Power Supply

Description

TO-220F

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp balasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDP12N60NZ	FDPF12N60NZ	Unit			
V _{DSS}	Drain to Source Voltage			6	V		
V _{GSS}	Gate to Source Voltage			±	V		
ID	Desia Current	- Continuous (T _C = 25 ^o C)	- Continuous (T _C = 25 ^o C)		12*	•	
	Drain Current	- Continuous (T _C = 100 ^o C)		7.2	7.2*	A	
I _{DM}	Drain Current	- Pulsed	- Pulsed (Note 1)		48*	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2		(Note 2)	565		mJ	
I _{AR}	Avalanche Current		(Note 1)	12		Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	24		mJ	
dv/dt	MOSFET dv/dt Ruggedness			2	V/ns		
	Peak Diode Recovery dv/	(Note 3)	10		V/ns		
P _D	Devues Dissinction	$(T_{C} = 25^{\circ}C)$	$(T_{\rm C} = 25^{\rm o}{\rm C})$		39	W	
	Power Dissipation	- Derate Above 25°C		2.0	0.3	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C		

*Drain current limited by maximum junction temperature

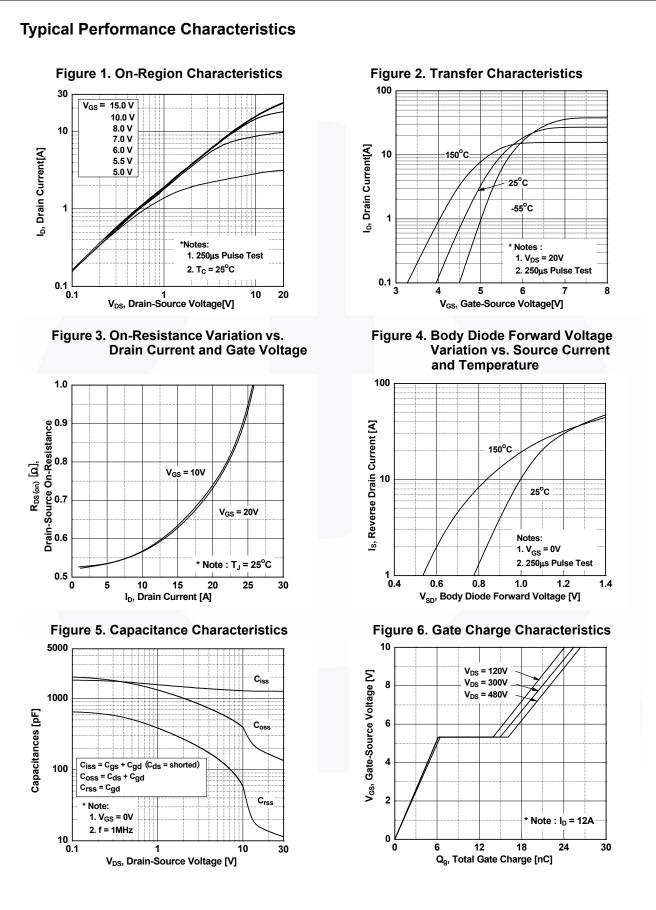
Thermal Characteristics

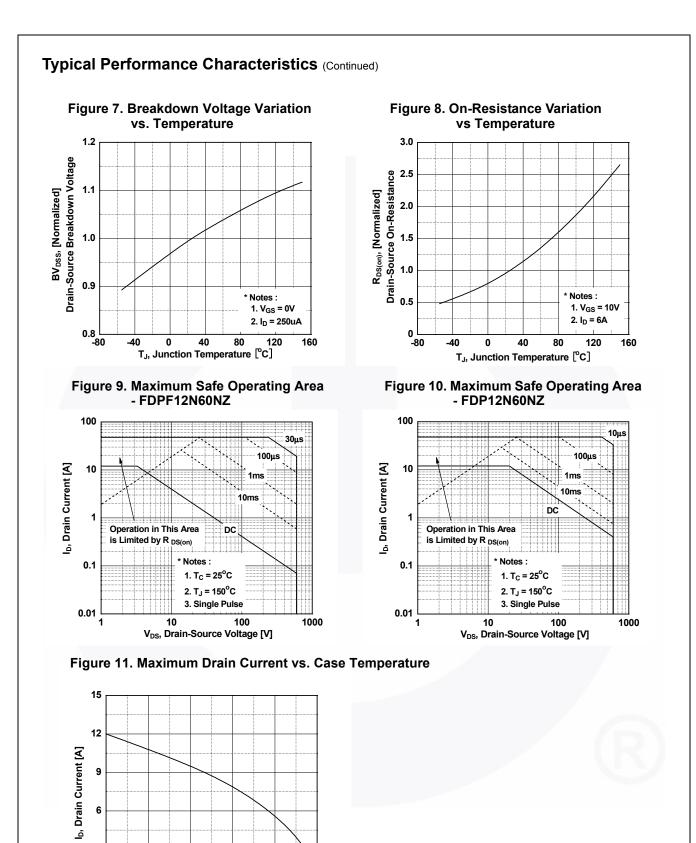
Symbol	Parameter	FDP12N60NZ	FDPF12N60NZ	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.0.523.2				
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	°C/W	

November 2013

Part Number To		Top Mark	Package	age Packing Method Reel Siz		e T	ape Width	Qu	antity	
FDP12N60NZ FDP12N60NZ		FDP12N60NZ	TO-220	Tube	N/A		N/A		50 units	
FDPF12	N60NZ	FDPF12N60NZ	TO-220F	Tube	N/A		N/A		50 units	
Electrica	l Chara	acteristics T _C = 25°C	unless othe	erwise noted.						
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit	
Off Charac	teristics				I.		,,		1	
BV _{DSS}	Drain to	Source Breakdown Voltage	lo =	: 250 μΑ, V _{GS} = 0 V, T	, = 25°C	600	-	-	V	
ABV _{DSS}		Proakdown Valtago Tomporaturo				000				
$/\Delta T_J$	Coefficient		I _D =	$I_D = 250 \ \mu$ A, Referenced to 25° C			0.6	-	V/ºC	
	Zero Gate Voltage Drain Current		V _{DS}	s = 600 V, V _{GS} = 0 V		-	-	1		
DSS			V _{DS}	$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			-	10	μA	
I _{GSS}	Gate to E	Body Leakage Current	V _{GS}	_S = ±30 V, V _{DS} = 0 V		-	-	±10	μA	
On Charac	teristics									
V _{GS(th)}		reshold Voltage	Ve	_S = V _{DS} , I _D = 250 μA		3	-	5	V	
R _{DS(on)}		ain to Source On Resistance	-	_S = 10 V, I _D = 6 A		-	0.53	0.65	Ω	
9FS		Transconductance	-	_S = 20 V, I _D = 6 A		-	13.5	-	S	
C _{iss}	Characteristics					<u>.</u>	1260	1676	pF	
C _{oss}	-	apacitance	V _D s	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	150	200	pF	
O _{oss} C _{rss}		Transfer Capacitance	f =				130	18	pF	
		te Charge at 10V		V _{DS} = 480 V, I _D = 12 A, V _{GS} = 10 V (Note 4)		-	26	34	nC	
Q _{g(tot)} Q _{gs}		Source Gate Charge				-	6	-	nC	
Q _{gd}		Drain "Miller" Charge	V G			-	10	-	nC	
		Ŭ								
Switching							1			
t _{d(on)}		Delay Time				-	25	60	ns	
t _r		Rise Time		$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 12 \text{ A},$		-	50	110	ns	
t _{d(off)}		Delay Time	vG	$_{\rm S}$ = 10 V, R _G = 25 Ω	_		80	170	ns	
t _f	Turn-Off	Fall Time		(Note 4)			60	130	ns	
Drain-Sou	rce Diod	e Characteristics								
I _S	Maximum Continuous Drain to Source Diode Forward Current					-	-	12	Α	
I _{SM}	Maximum Pulsed Drain to Source Diode Fo			orward Current		-	-	48	Α	
V _{SD}	Drain to S	Source Diode Forward Voltag	ge V _{GS}	V _{GS} = 0 V, I _{SD} = 12 A			-	1.4	V	
t _{rr}	Reverse	Reverse Recovery Time Reverse Recovery Charge		$V_{GS} = 0 V, I_{SD} = 12 A,$ $dI_F/dt = 100 A/\mu s$		-	350		ns	
Q _{rr}	Reverse					-	2.2	-	μC	

2





T_c, Case Temperature [°C]

75

100

125

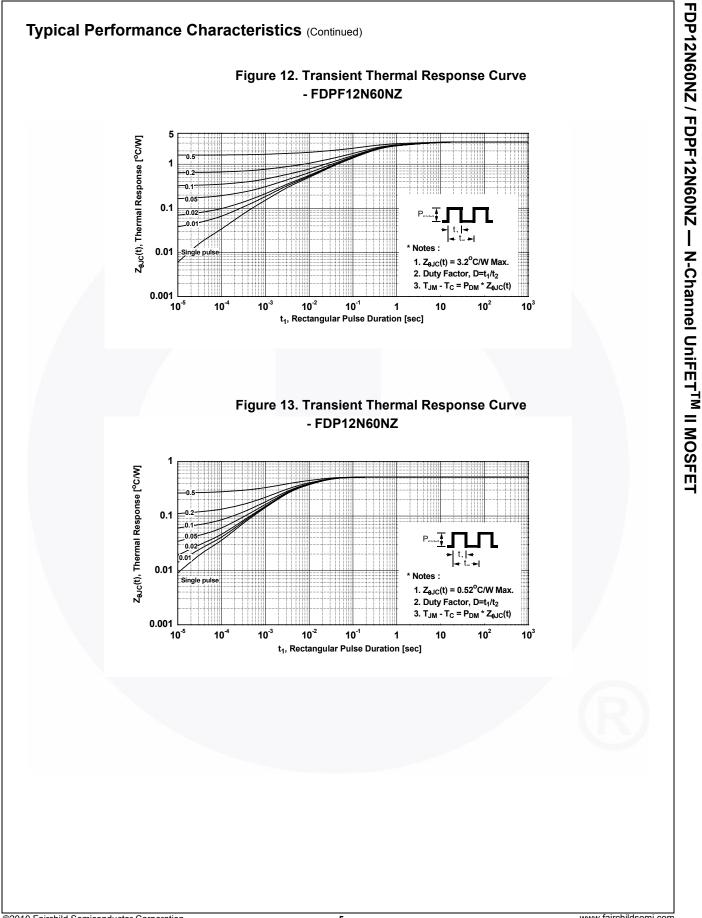
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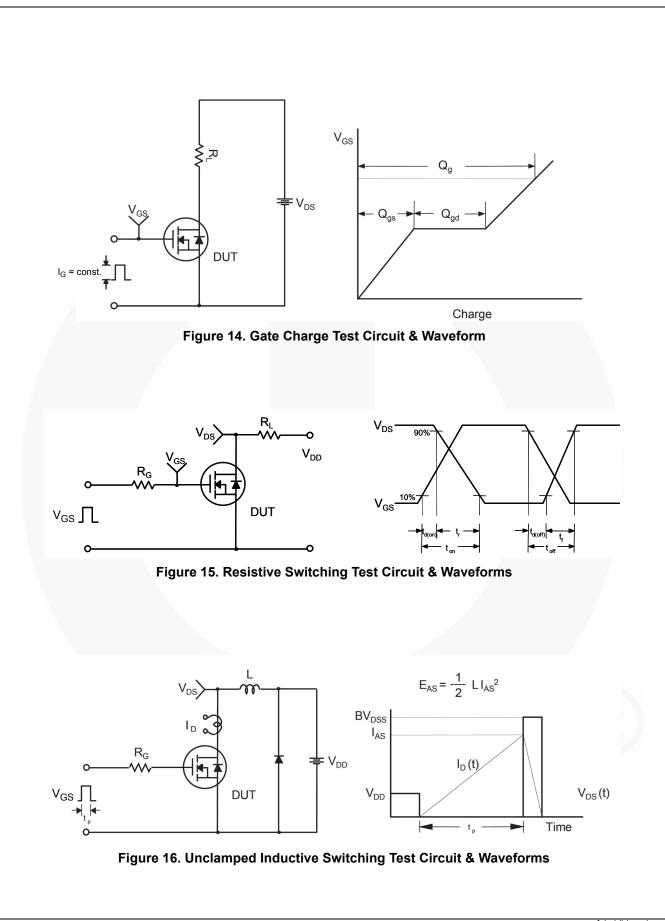
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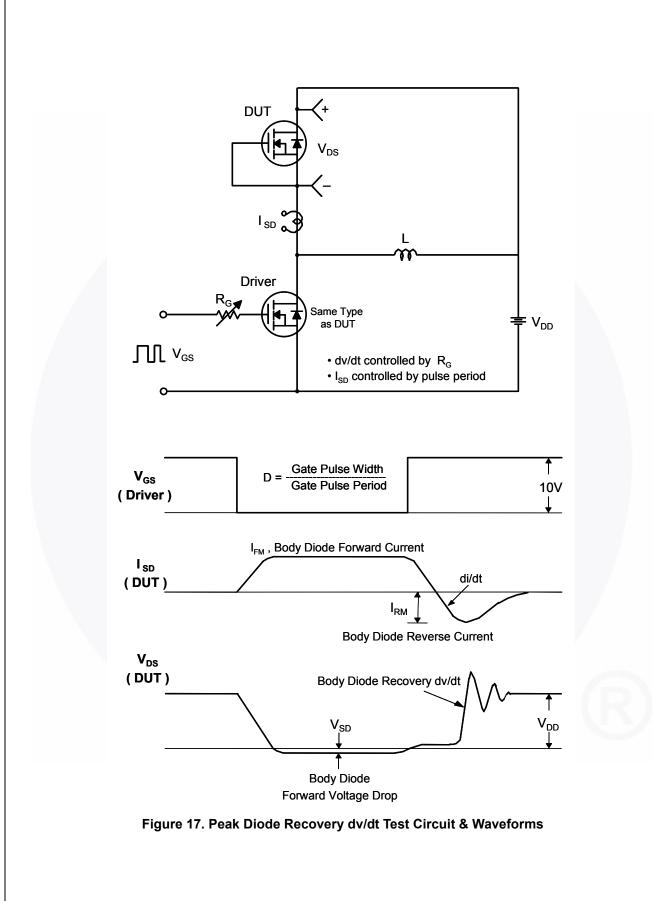
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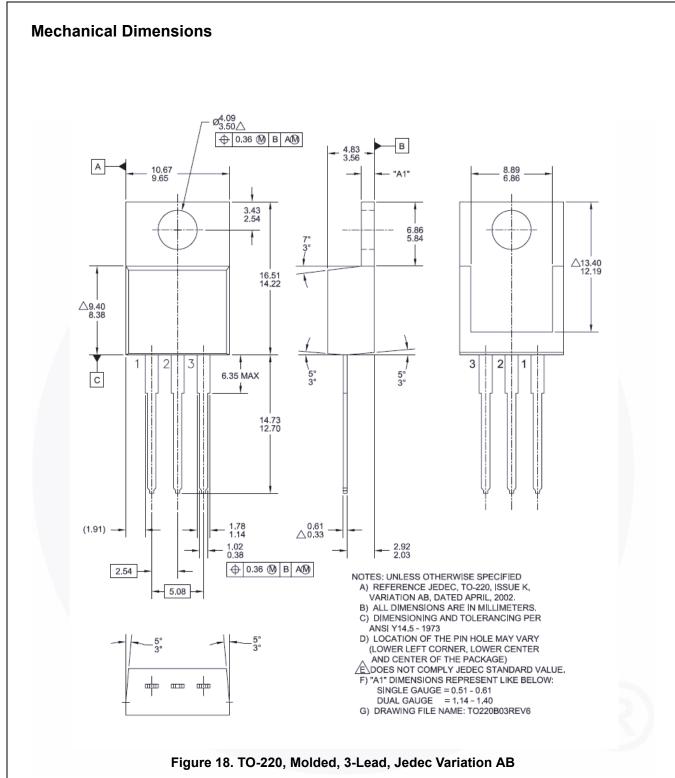
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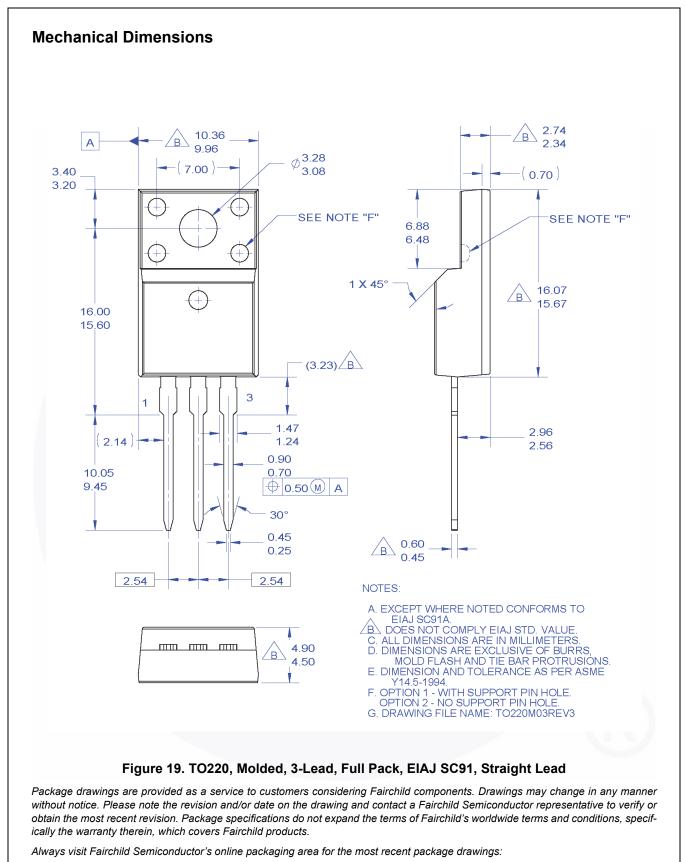


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FDP12N60NZ / FDPF12N60NZ — N-Channel UniFETTM II MOSFET



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N-Channel UniFETTM II MOSFET



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